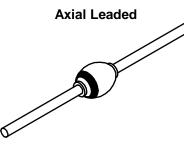
Solid State Devices, Inc. 14701 Firestone Blvd * La Mirada, Ca 90638 Phone: (562) 404-4474 * Fax: (562) 404-1773		SDR9JUF & UFSMS thru SDR9MUF & UFSMS			
ssdi@ssdi-power.com * www.ssdi-power.com DESIGNER'S DATA SHEET Part Number / Ordering Information 1^{J} SDR9_UF UF L Screening ^{2/} = None TX = TX Level TXV = TXV Level S = S Level L Package = None SMS = Surface Mount Square Tab L Recovery Time UF = Ultra Fast Voltage J = 600 V K = 800 V M = 1000 V		9 AMP 800-1000 Volts 70 nsec ULTRA FAST RECOVERY RECTIFIER Features: • Ultra Fast Recovery: 70 nsec maximum • PIV to 1000 Volts • Low Reverse Leakage Current • Hermetically Sealed • Single Chip Construction • Replaces Larger DO-4 Rectifiers • Low Thermal Resistance • Fast and Hyper Fast Recovery Available. Contact Factory. • TX, TXV, and S-Level Screening Available ²⁷			
Maximum Ratings		Symbol	Value	Units	
DC Blocking Voltage	SDR9JUF & UFSM SDR9KUF & UFSM SDR9MUF & UFSM	IS V _{RWM}	600 800 1000	Volts	
Average Rectified Forward Current (Resistive Load, 60 Hz Sine Wave, $T_A = 25^{\circ}C$)		Іо	9	Amps	
Repetitive Peak Surge Current (8.3 ms Pulse, Half Sine Wave Superimposed on Io, Allow Junction to Reach Equilibrium Between Pulses, $T_A = 25^{\circ}C$)) I _{FSM}	125	Amps	
Operating & Storage Temperature		Top & Tstg	-65 to +175	°C	

Junction to Leads, L = .125 " (Axial Lead) Junction to End Tab (Surface Mount)

Maximum Thermal Resistance

Notes:

<u>1</u>/ For Ordering Information, Price, Operating Curves, and Availability – Contact Factory.
<u>2</u>/ Screening Based on MIL-PRF-19500. Screening Flows Available on Request.



SMS

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DATA SHEET #: RC0057C

 $R_{\theta JL}$

 $R_{\theta JE}$

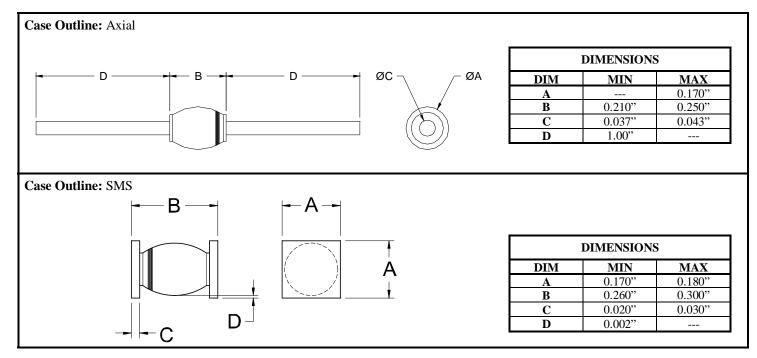
DOC

°C/W



SDR9JUF & UFSMS thru SDR9MUF & UFSMS

Electrical Characteristics		Symbol	Min	Max	Units
Instantaneous Forward Voltage Drop (300-500 µs pulse)	$I_{\rm F} = 3A, T_{\rm A} = 25^{\circ}{\rm C}$ $I_{\rm F} = 9A, T_{\rm A} = 25^{\circ}{\rm C}$ $I_{\rm F} = 9A, T_{\rm A} = -55^{\circ}{\rm C}$	$\begin{array}{c} V_{F1} \\ V_{F2} \\ V_{F3} \end{array}$	 	1.50 1.90 2.10	Vdc
Reverse Leakage Current (Rated V _R , 300 µs pulse minimum)	$T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$	I _{R1} I _{R2}		10 250	μA
Junction Capacitance $(V_R = 10 \text{ V}, T_A = 25^{\circ}\text{C}, f = 1\text{MHz})$		C _J		80	pF
Reverse Recovery Time ($I_F = 500 \text{ mA}, I_R = 1\text{A}, I_{RR} = 0.25\text{A}, T_A = 25^{\circ}\text{C}$)		t _{rr}		70	nsec



Notes:

Consult manufacturing for operating curves.

NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.	DATA SHEET #: RC0057C	DOC
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